

3CP-RJ45-GEN 10/100/1000M Copper SFP Transceiver

Features

- Up to 1.25Gb/s bi-directional data links
- Hot-pluggable SFP footprint
- Extended case temperature range (0°C to +70°C)
- Fully metallic enclosure for low EMI
- Low power dissipation (1.05 W typical)
- Compact RJ-45 connector assembly
- Access to physical layer IC via 2-wire serial bus
- 1000 BASE-T operation in host systems with SERDES interface
- 10/100/1000Mbps compliant in host systems with SGMII interface

Applications

• 1.25 Gigabit Ethernet over Cat 5 cable

Description

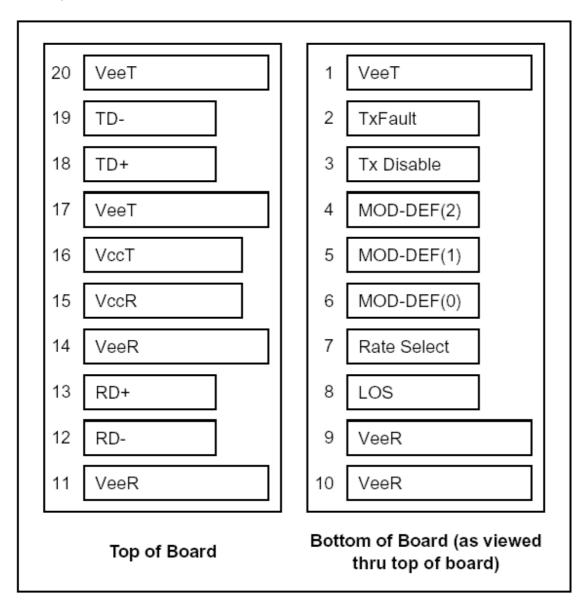
3c-Link's 3CP-RJ45-GEN Copper Small Form Pluggable (SFP)transceivers is high performance, cost effective module compliant with the Gigabit Ethernet and 1000- BASE-T standards as specified in IEEE 802. 3-2002 and IEEE 802.3ab, which supp- orting 1000Mbps data- rate up to 100 meters reach over unshielded twisted-pair category 5 cable. The module supports1000 Mbps full duplex data-links with 5-level Pulse Amplitude Modulation (PAM) signals. All four pairs in the cable are used with symbol rate at 250Mbps on each pair. The module provides standard serial ID information compliant with SFP MSA, which can be accessed with address of A0h via the 2wire serial CMOS EEPROM protocol. The physical IC can also be accessed via 2wire serial bus at address A0h.





Pin Definitions

Pin Diagram







Pin	Signal Name	Description	Plug Seq.	Notes
1	Veet	Transmitter Ground	1	
2	TX FAULT	Transmitter Fault Indication	3	Note1
3	TX DISABLE	Transmitter Disable	3	Note2
4	MOD_DEF(2)	SDA Serial Data Signal	3	Note3
5	MOD_DEF(1)	SCL Serial Clock Signal	3	Note3
6	MOD_DEF(0)	TTL Low	3	Note3
7	Rate Select	Not Connected	3	
8	LOS	Loss of Signal	3	Note 4
9	Veer	Receiver ground	1	
10	V _{EER}	Receiver ground	1	
11	VEER	Receiver ground	1	
12	RX-	Inv. Received Data Out	3	Note 5
13	RX+	Received Data Out	3	Note 5
14	Veer	Receiver ground	1	
15	Vccr	Receiver Power Supply	2	
16	Vсст	Transmitter Power Supply	2	
17	Veet	Transmitter Ground	1	
18	TX+	Transmit Data In	3	Note 6
19	TX-	Inv. Transmit Data In	3	Note 6
20	Veet	Transmitter Ground	1	

Notes:

Plug Seq.: Pin engagement sequence during hot plugging.

 TX Fault is an open collector output, which should be pulled up with a 4.7k~10kΩ resistor on the host board to a voltage between 2.0V and Vcc+0.3V. Logic 0 indicates normal operation; logic 1 indicates a laser fault of some kind. In the low state, the output will be pulled to less than 0.8V.

2) TX Disable is an input that is used to shut down the transmitter optical output. It is pulled up within the module with a 4.7 °C 10 K resistor. Its states are:

Low (0 to 0.8V):	Transmitter on
(>0.8, < 2.0V):	Undefined
High (2.0 to 3.465V):	Transmitter Disabled
Open:	Transmitter Disabled

3) Mod-Def 0,1,2. These are the module definition pins. They should be pulled up with a 4.7K to 10K resistor on the host board. The pull-up voltage shall be VccT or VccR

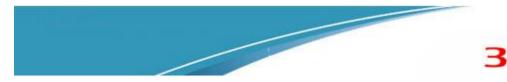
Mod-Def 0 is grounded by the module to indicate that the module is present

Mod-Def 1 is the clock line of two wire serial interface for serial ID

Mod-Def 2 is the data line of two wire serial interface for serial ID

- 4) LOS (Loss of Signal) is an open collector/drain output, which should be pulled up with a 4.7K to 10K resistor. Pull up voltage between 2.0V and VccT, R+0.3V. When high, this output indicates the received optical power is below the worst-case receiver sensitivity (as defined by the standard in use). Low indicates normal operation. In the low state, the output will be pulled to <0.8V.</p>
- 5) RD-/+: These are the differential receiver outputs. They are AC coupled 100 differential lines which should be terminated with 100 (differential) at the user SERDES.
- 6) TD-/+: These are the differential transmitter inputs. They are AC-coupled, differential lines with 100 differential termination inside the module.





+3.3V Volt Electrical Power Interface

The 3CP-RJ45-GEN has an input voltage range of +5V +/- 5%. The 3.3V maximum voltage is not allowed for continuous operation.

Table 1. +3.3V Volt electrical power interface

+3.3V volt Electrical Power Interface									
Parameter	Min	Тур	Max	Units	Notes/Conditions				
Supply Current	ls		320	375	mA	1.2W max power over full range of voltage and temperature. See caution note below			
Input Voltage	Vcc	3.13	3.3	3.47	V	Referenced to GND			
Maximum Voltage	Vmax			4	V				
Surge Current	Isurge			30	mA	Hot plug above steady state current. See caution note below			

Caution: Power consumption and surge current are higher than the specified values in the SFP MSA

Low-Speed Signals

MOD_DEF(1) (SCL) and MOD_DEF(2) (SDA), are open drain CMOS signals (see section VII, "Serial Communication Protocol"). Both MOD_DEF(1) and MOD_DEF(2) must be pulled up to host_Vcc. **Table 2. Low-speed signals, electronic characteristics**

Low-Speed Signals, Electronic Characteristics										
Parameter	Symbol	Min	Max	Units	Notes/Conditions					
SFP Output LOW	VOL	0	0.5	V	4.7k to 10k pull-up to host_Vcc, measured at host side of connector					
SFP Output HIGH	VOH	host_Vcc - 0.5	host_Vcc + 0.3	V	4.7k to 10k pull-up to host_Vcc, measured at host side of connector					
SFP Input LOW	VIL	0	0.8	V	4.7k to 10k pull-up to Vcc, measured at SFP side of connector					
SFP Input HIGH	VIH	2	Vcc + 0.3	V	4.7k to 10k pull-up to Vcc, measured at SFP side of connector					

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High-Speed Electrical Interface

All high-speed signals are AC-coupled internally.

High-Speed Electrical Interface Transmission Line-SFP									
Parameter Symbol Min Typ Max Units Notes/Conditions									
Line Frequency	fL		125		MHz	5-level encoding, per IEEE 802.3			
Tx Output Impedance	Zout,TX		100		Ohm	Differential, for all Frequencies between 1MHz and 125MHz			
Rx Input Impedance	Zin,RX		100		Ohm	Differential, for all Frequencies between 1MHz and 125MHz			

High-speed electrical interface, host-SFP

Table 4. High-speed electrical interface, host-SFP

High-Speed Electrical Interface, Host-SFP								
Parameter	Symbol	Min	Тур	Max	Units	Notes/Conditions		
Single ended data input swing	Vinsing	250		1200	mV	Single ended		
Single ended data output swing	Voutsing	350		800	mV	Single ended		
Rise/Fall Time	Tr,Tf		175		psec	20%-80%		
Tx Input Impedance	Zin		50		Ohm	Single ended		
Rx Output Impedance	Zout		50		Ohm	Single ended		

General Specifications

Table 5. General specifications

General									
Parameter Symbol Min Typ Max Units Notes/Conditions						Notes/Conditions			
Data Rate	BR	10		1,000	Mb/sec	IEEE 802.3 compatible. See Notes 2 through 4 below			
Cable Length	L			100	m	Category 5 UTP. BER <10-12			

Notes:

1. Clock tolerance is +/- 50 ppm

2. By default, the 3CP-RJ45-GEN is a full duplex device in preferred master mode

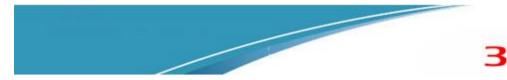
3. Automatic crossover detection is enabled. External crossover cable is not required

4. 1000 BASE-T operation requires the host system to have an SGMII interface with no clocks, and the module PHY to be configured per Application Note AN-2036. With a SERDES that does not support SGMII, the module will operate at 1000BASE-T only.

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Environmental Specifications

Table 6. Environmental specifications

Environmental Specifications									
Parameter	Symbol	Min	Тур	Max	Units	Notes/Conditions			
Operating Temperature	Тор	0		70	°C	Case temperature			
Storage Temperature	Tsto	-40		85	°C	Ambient temperature			

References

1. Gigabit Interface Converter (SFP) Transceiver Multi-Source Agreement (MSA),

- 2. IEEE Std 802.3, 2002 Edition. IEEE Standards Department, 2002.
- 3. "AT24C01A/02/04/08/16 2-Wire Serial CMOS E2PROM", Atmel Corporation.

4. "Alaska Ultra 88E1111 Integrated 10/100/1000 Gigabit Ethernet Transceiver", Marvell Corporation.

Mechanical Specifications

The host-side of the 3CP-RJ45-GEN conforms to the mechanical specifications outlined in the SFP MSA1. The front portion of the SFP (part extending beyond the face plate of the host) is larger to accommodate the RJ-45 connector.

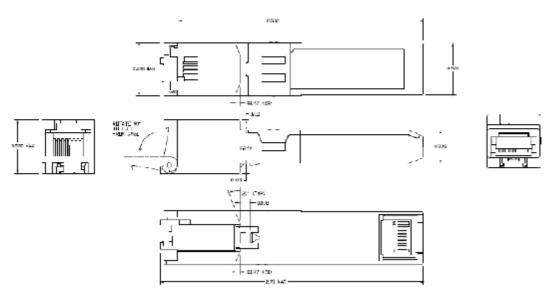


Figure 2. 3CP-RJ45-GEN mechanical dimensions





References

- 1. Small Form Factor Pluggable (SFP) Transceiver Multi-Source Agreement (MSA),
- 2. IEEE Std 802.3, 2002 Edition. IEEE Standards Department, 2002.
- 3. "AT24C01A/02/04/08/16 2-Wire Serial CMOS E2PROM", Atmel Corporation.

Ordering information

Part number	Operating Case temperature
3CP-RJ45-GEN	10/100/1000Mbps, Copper SFP with spring latch



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